

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT2941880

<b>SUBMISSION TYPE:</b>	CORRECTIVE ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	Corrective Assignment to correct the ADDRESS OF THE ASSIGNEE previously recorded on Reel 033243 Frame 0030. Assignor(s) hereby confirms the ASSIGNMENT.
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
MEIJO UNIVERSITY	07/01/2014
NATIONAL UNIVERSITY CORPORATION KYOTO INSTITUTE OF TECHNOLOGY	06/19/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	EL-SEED CORPORATION
<b>Street Address:</b>	3-1804-2, UMEGAOKA, TENPAKU-KU,
<b>City:</b>	NAGOYA-SHI, AICHI
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	468-0001
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Patent Number:</b>	7855385
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(310)496-2444
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	1-310-880-0976
<b>Email:</b>	jimu@yokoi.or.jp
<b>Correspondent Name:</b>	TOSHIYUKI YOKOI
<b>Address Line 1:</b>	707 WILSHIRE BL. #4360
<b>Address Line 4:</b>	LOS ANGELES, CALIFORNIA 90017
<b>ATTORNEY DOCKET NUMBER:</b>	PCT08-1001
<b>NAME OF SUBMITTER:</b>	TOSHIYUKI YOKOI
<b>SIGNATURE:</b>	/ty/
<b>DATE SIGNED:</b>	07/16/2014
<b>Total Attachments: 5</b>	
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2014. 7.3 譲渡証提出

06007-3  
40025-1  
PCT08-1001

## PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>MEIJO UNIVERSITY</td><td>07/01/2014</td></tr><tr><td>NATIONAL UNIVERSITY CORPORATION KYOTO INSTITUTE OF TECHNOLOGY</td><td>06/19/2014</td></tr></tbody></table>	Name	Execution Date	MEIJO UNIVERSITY	07/01/2014	NATIONAL UNIVERSITY CORPORATION KYOTO INSTITUTE OF TECHNOLOGY	06/19/2014					
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Fax Number: (310)496-2444 Phone: 1-310-880-0976 Email: jimu@yokoi.or.jp <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> Correspondent Name: TOSHIYUKI YOKOI Address Line 1: 707 WILSHIRE BL #4360 Address Line 4: LOS ANGELES, CALIFORNIA 90017											
ATTORNEY DOCKET NUMBER:	PCT08-1001										
NAME OF SUBMITTER:	TOSHIYUKI YOKOI										
Signature:	/ty/										
Date:	07/03/2014										
Total Attachments: 3 source=Assignment_Meijo#page1.tif source=Assignment_Kyoto#page1.tif source=PCT08-1001_coversheet#page1.tif											
RECEIPT INFORMATION											

PATENT

REEL: 033347 FRAME: 0244

2014/07/04 05:1

EPAS ID:	PAT2926363
Receipt Date:	07/03/2014

**U.S. PATENT ASSIGNMENT**

WHEREAS, **Meijo University**, having an address of 1-501, Shiogamaguchi, Tempaku-ku, Nagoya-shi, Aichi, 468-8502, JAPAN, hereinafter referred to as ASSIGNOR, is the 50% of the entire right, title and interest of the following U.S. patent:

United States Patent Registration No. 7,855,385, entitled  
"SIC CRYSTAL AND SEMICONDUCTOR DEVICE".

WHEREAS, **EL-SEED Corporation**, having an address of 3-1804-2, Umegaoka, Tempaku-ku, Nagoya-shi, Aichi, 468-0001, JAPAN, hereinafter referred to as ASSIGNEE, is desirous of acquiring the above 50% of the entire right, title and interest of to the above U.S. patent registration as held by ASSIGNOR;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: be it known that in consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR hereby sells, assigns, and transfers to ASSIGNEE, the 50% of the entire right, title, and interest of United States Patent Registration No. 7,855,385 for the full terms thereof the U.S. patents and any reissue or reexamination patents issued therefrom.

IN WITNESS WHEREOF, the undersigned ASSIGNOR has hereunto set hand and seal this

1st day of July, 2014.

Assignor: **Meijo University**

Signature: \_\_\_\_\_

*Hideo Ogasawara*

Name: *Hideo Ogasawara*

Title: *Chairman, Board of Trustees*

**U.S. PATENT ASSIGNMENT**

WHEREAS, **NATIONAL UNIVERSITY CORPORATION KYOTO INSTITUTE OF TECHNOLOGY**, having an address of 1, Matsugasaki Hashikami-cho, Sakyo-ku, Kyoto-shi, Kyoto, 606-8585, JAPAN, hereinafter referred to as ASSIGNOR, is the 50% of the entire right, title and interest of the following U.S. patent:

United States Patent Registration No. **7,855,385**, entitled  
"SiC CRYSTAL AND SEMICONDUCTOR DEVICE".

WHEREAS, **EL-SEED Corporation**, having an address of 3-1804-2, Umegaoka, Tenpaku-ku, Nagoya-shi, Aichi, 468-0001, JAPAN, hereinafter referred to as ASSIGNEE, is desirous of acquiring the above 50% of the entire right, title and interest of to the above U.S. patent registration as held by ASSIGNOR;

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IN WITNESS WHEREOF, the undersigned ASSIGNOR has hereunto set hand and seal this

19<sup>th</sup> day of June, 2014.

Assignor: **NATIONAL UNIVERSITY CORPORATION KYOTO INSTITUTE OF TECHNOLOGY**

Signature: \_\_\_\_\_

Name:

*Masao Furuyama*

Title:

*President*